

PCB capability and services	1.Single-sided,double side & multi-layer PCB. FPC. Flex Rigid PCB with competitive price, good quality and excellent service.	
	2. CEM-1, CEM-3 FR-4, FR-4 High TG, Aluminum base material, Polyimide, etc.	
	3. HAL, HAL lead free, Immersion Gold/ Silver/Tin, OSP surface treatment.	
	4. Quantities range from sample to mass order	
	5. 100% E-Test	
SMT(Surface Mounting technology), DIP	1. Material Sourcing Service	
	2. SMT assembly and Through hole components insertion	
	3.100% AOI testing	
	4. IC pre-programming / Burning on-line	
	5.ICT testing	
	6.Function testing as requested	
	7.Complete Unit assembly (which including plastics, metal box, Coil, cable inside etc.)	
	8.Conformal coating	
	9.OEM/ODM also welcomed	
Production Capacity	PCB Max. size	DIP capacity
	Min component size	201
	Min.pin space of IC	0.3mm
	Min. space of BGA	0.3mm
	Max.precision of IC assembly	±0.03mm
	SMT capacity	≥2 million points/day
	DIP capacity	≥100k parts/day
EMS Capacity	electronic product final assembl	100k/month